

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT7911774

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	L & T TECHNOLOGY SERVICES LIMITED	06/06/2018
RECEIVING PARTY DATA		
Name:	MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED	
Street Address:	DLF CYBER CITY, BLOCK NO. 3, GROUND FLOOR	
Internal Address:	PLOT NO. 129 TO 132, APHB COLONY, GACHIBOWLI, HYDERABAD	
City:	ANDHRA PRADESH	
State/Country:	INDIA	
Postal Code:	500019	
PROPERTY NUMBERS Total: 2		
	Property Type	Number
	Application Number:	18137044
	Application Number:	17480441
CORRESPONDENCE DATA		
Fax Number:	(203)492-5785	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	2034925000	
Email:	rs.patents.two@medtronic.com, nrispone@carterdeluca.com	
Correspondent Name:	COVIDIEN LP	
Address Line 1:	60 MIDDLETOWN AVENUE	
Address Line 2:	MAILSTOP 54, LEGAL DEPT.	
Address Line 4:	NORTH HAVEN, CONNECTICUT 06473	
ATTORNEY DOCKET NUMBER:	C00017632US02DIV	
NAME OF SUBMITTER:	THOMAS E. KEELY	
SIGNATURE:	/Thomas E. Keely/	
DATE SIGNED:	04/20/2023	
Total Attachments: 4		
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DEED OF ASSIGNMENT

This Deed of Assignment is executed by:

L&T TECHNOLOGY SERVICES LIMITED, having its registered office at L&T House, Ballard Estate, Mumbai 400001, India, and its representatives and affiliates (hereinafter referred to as "Assignor");

and, **MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED**, having offices at DLF Cybercity, Block No. 3, Ground Floor, Plot No. 129 to 132 APHB Colony, Gachibowli, Hyderabad – 500019, Andhra Pradesh, India (hereinafter referred to as "Assignee").

WHEREAS, Assignor and Assignee entered into an Engineering Development Agreement dated October 17, 2011;

WHEREAS the Engineering Development Agreement transferred and assigned, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, all right, title and interest in any and all intellectual property, trade secrets and knowledge, including but not limited to methods, ideas, apparatuses, compositions, drawings, abstracts, specifications, inventions, written material, audiovisual material, formulas, data, computer software and rights related thereto, including but not limited to copyrights, trademarks, patents, patent applications, trade secrets, and other properties developed by Assignor or Assignee under the Engineering Development Agreement either jointly or individually ("Intellectual Property");

WHEREAS, Assignor hereby acknowledges, by virtue of the Engineering Development Agreement, Assignor transferred to Assignee all right, title and interest in and to the inventions and applications (including any continuations, continuations-in-part, divisionals, RCE's or other parent or child applications or inventions) and to all foreign counterparts thereof (including patent, utility model and industrial designs), as listed on the attached *Schedule A*, and in and to any Letters Patent and Registrations which may hereafter be granted on any patent applications claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the applications as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Deed of Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof;

WHEREAS Assignor desires to ensure to that to the extent any of Assignor's right, title and interest in the foregoing Intellectual Property, including the patents and applications listed on the attached *Schedule A*, are deemed not transferred from Assignor to Assignee, that any such past, present and future rights, title and interest in the foregoing Intellectual Property be presently assigned to Assignee.

[CONTINUED ON NEXT PAGE]

NOW, THEREFORE, the parties agree as follows:

ASSIGNOR: L&T TECHNOLOGY SERVICES LIMITED

Hereby sells, assigns and transfers to

ASSIGNEE: MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED

And the successors, assigns and legal representatives of the ASSIGNEE any and all rights, title and interest ASSIGNOR may have, if any, including the right to sue for present, past and future infringement, in the United States, its territorial possessions, and in all foreign countries, including all treaty and convention rights, the Intellectual Property, including the inventions and applications (including any continuations, continuations-in-part, divisionals, RCE's or other parent or child applications or inventions) and to all foreign counterparts thereof (including patent, utility model and industrial designs), as listed on the attached *Schedule A*, and in and to any Letters Patent and Registrations which may hereafter be granted on any patent applications claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the applications as provided by the Paris Convention.

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IN TESTIMONY WHEREOF, Assignor has signed his name on the date indicated.

L&T TECHNOLOGY SERVICES LIMITED

**MEDTRONIC ENGINEERING AND
INNOVATION CENTER PRIVATE
LIMITED**



Printed Name: BHUPENDRA BHATE

Title: COO

Dated: 6th JUNE 2018



Printed Name: DIVYA PRAKASH JOSHI

Title: SITE DIRECTOR, MEIC

Dated: 04 Sep 2018

WITNESS



Printed Name: Ramesh S Rao

Dated: 18 - June - 2018

WITNESS



Printed Name: AMARSINH JADHAV.

Dated: 04 SEPT-2018

SCHEDULE A

Patents and Patent Applications

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